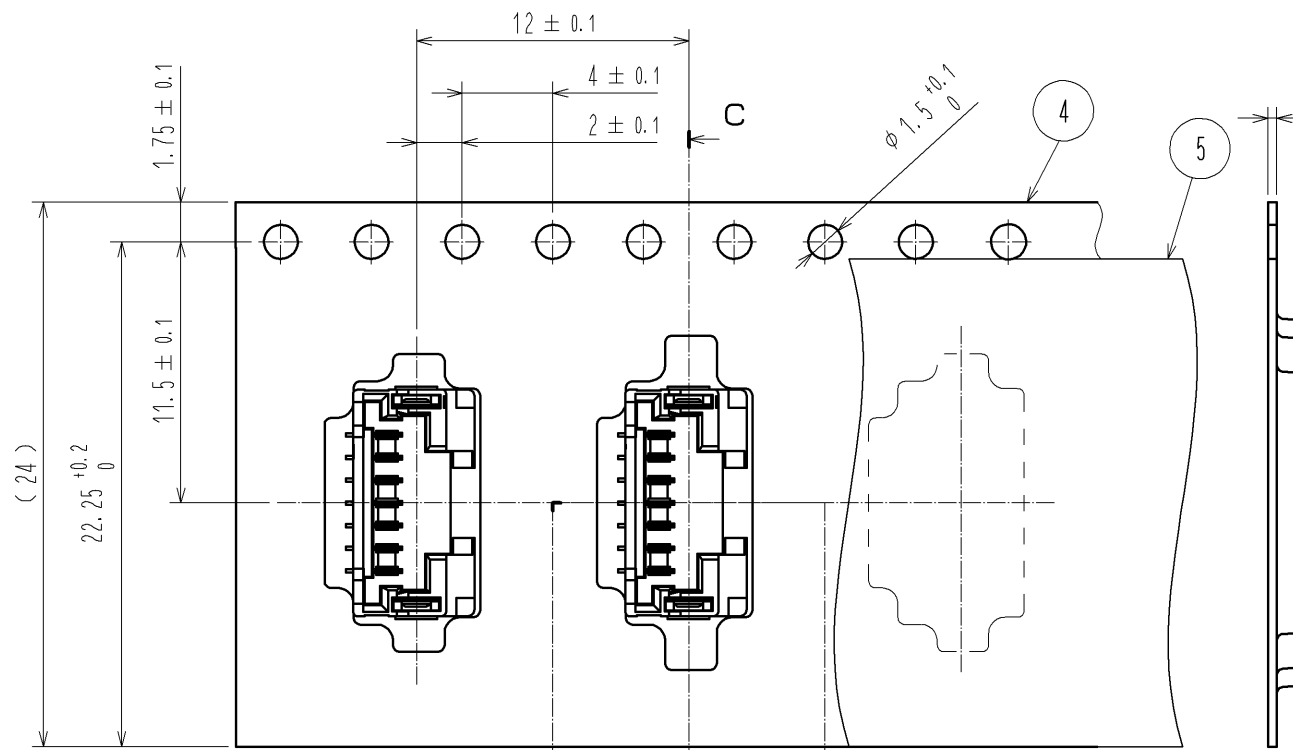
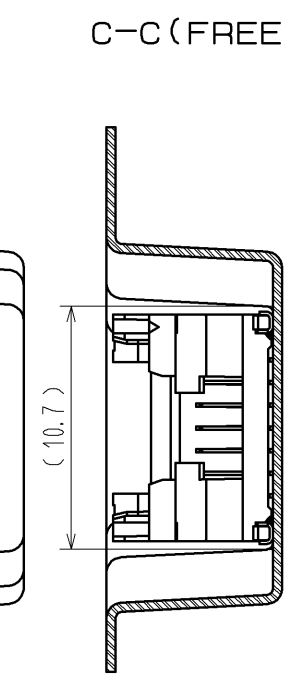


- NOTES 1. LEAD CO-PLANARITY SHALL BE 0.1mm MAX  
 2. AREA INDICATED MUST BE FREE OF CONDUCTIVE TRACES OR THE CONDUCTIVE TRACES MUST BE COVERED BY RESIST FILM.  
 3. PLEASE CONSULT HIROSE WHEN THE PRODUCT IS MOUNTED TO FPC.

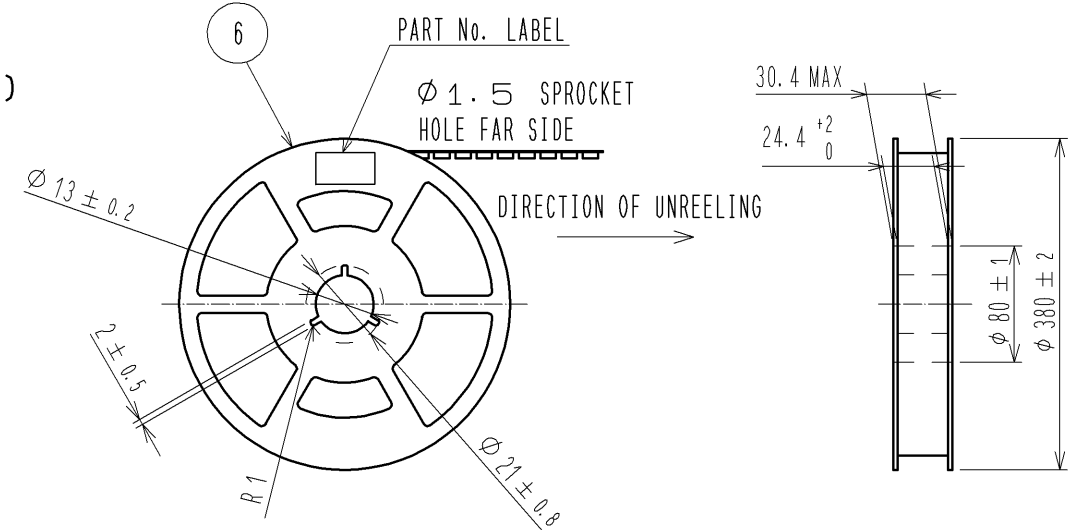
3	PHOSPHOR BRONZE	CONTACT AREA : Sn PLATING 1μm MIN UNDER PLATING : Cu PLATING 0.3μm MIN			
2	BRASS	CONTACT AREA : Au PLATING 0.05μm MIN LEAD AREA : Au PLATING 0.05μm MIN UNDER PLATING : Ni PLATING 1μm MIN	6	PS	REEL . BLACK
1	LCP	BLACK . UL94V-0	5	POLYESTER	CLEAR
			4	PS	CLEAR
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 5 : 1	COUNT		DESCRIPTION OF REVISIONS
DESIGNED		CHECKED		DATE	
APPROVED : KI. AKIYAMA		13.05.15		DRAWING NO. EDC3-329664-01	
CHECKED : HK. UMEHARA		13.05.15		PART NO. DF50A-7P-1V(51)	
DESIGNED : ST. SATO		13.05.15		CODE NO. CL665-1012-0-51	
DRAWN : MI. SAKIMURA		12.06.28			



C-C (FREE)



STYLE AND DIMENSION OF REEL (FREE)

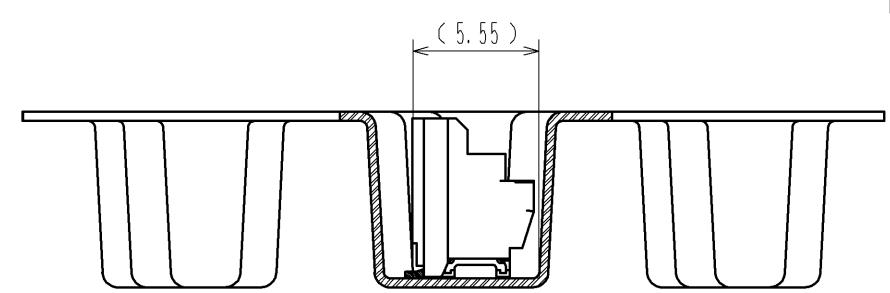


DETAIL OF PART No. LABEL

生産月日	年 月 日
図 番	CL665-1012-0-51
品 名	DF50A-7P-1V(51)
納入数量	1000 KO
納入者	ヒロセ電機(株)

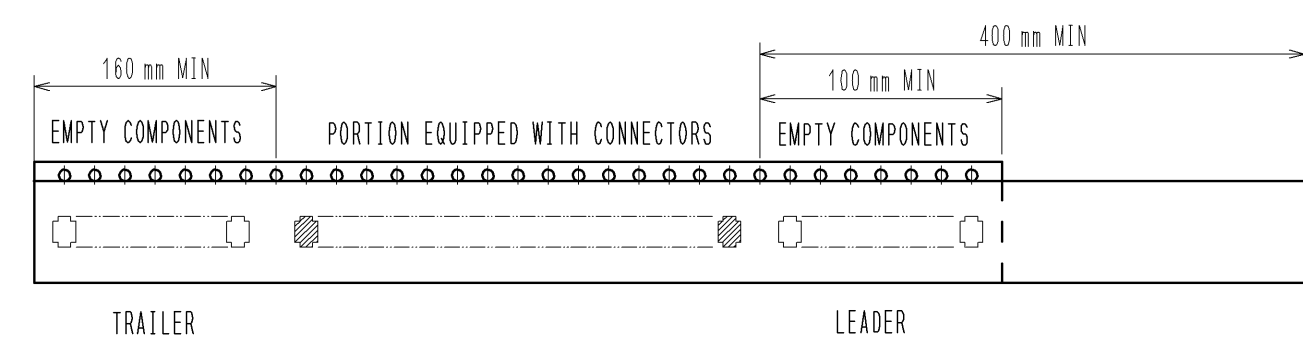
- SUPPLIER
- QUANTITY
- PART No.
- CODE No.
- DATE OF MANUFACTURED

B-B (FREE)

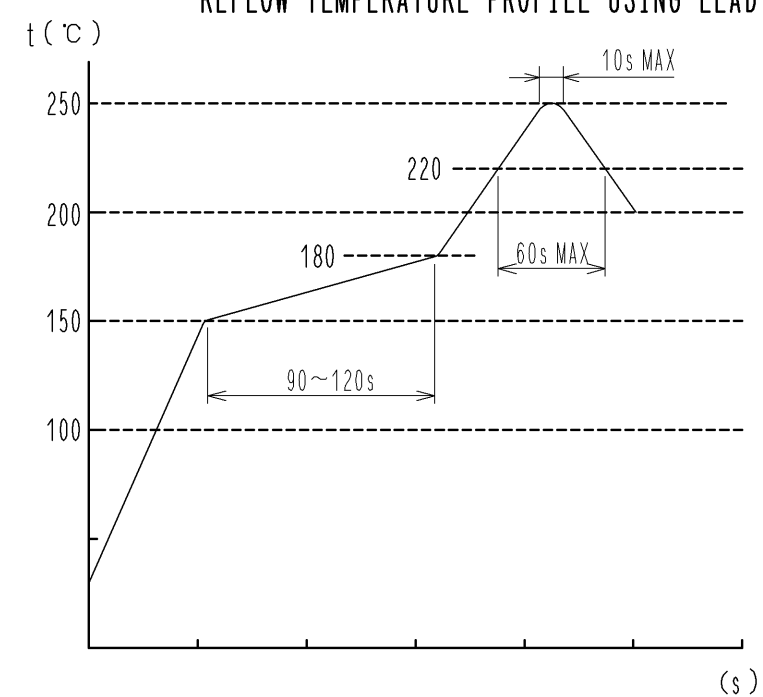


DIRECRION OF UNREELING →

5 TAPING (FREE)



REFLOW TEMPERATURE PROFILE USING LEAD-FREE SOLDER PASTE (REFERENCE)



NUMBER OF REFLOW CYCLES 2 CYCLES MAX.  
THE TEMPERATURE IS MEASURED IN THE TERMINAL LEAD PART.

ADDITIONAL FACTORS, SUCH AS SOLDER PASTE TYPE, PCB SIZE AND OTHER MOUNTED COMPONENTS COULD AFFECT THE PROFILE. THEREFORE, A THOROUGH EVALUATION OF MOUNTING CONDITION IS REQUIRED PRIOR TO PRODUCTION. TEMPERATURE IS MEASURED AT CONTACT LEAD.

NOTE 4. 1 REEL : 1000 CONNECTORS  
5 REEL TO JIS C 0806. (PACKAGING OF COMPONENTS FOR AUTOMATIC HANDLING)  
6. THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

<b>HRS</b>	図番:	EDC3-329664-01
	製品名:	DF50A-7P-1V(51)
	製品コード:	CL665-1012-0-51